

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Wu, Chung-Chen; Chen, Ming-Tzu
Assignee: Delta Electronics, Inc.
Title: Method for Packing Electronic Devices by Interconnecting Frame Body
and Frame Leads with Insulating Block and its Packing Structure
Serial No.: Unknown Filing Date: Herewith
Examiner: Unassigned Group Art Unit: Unassigned
Docket No.: AB-1088-1D US

Irvine, California
November 17, 2003

PRELIMINARY AMENDMENT

Dear Sir:

Prior to any substantive examination of the present application, please amend as follows.

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